

EXPEDITED PROCEDURE – EXAMINING GROUP 1725

S/N 10/823,314

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Neo C. Peng et al.

Examiner: Samuel M Heinrich

Serial No.: 10/823,314

Group Art Unit: 1725

Filed: April 13, 2004

Docket No.: 303.772US2

Title: WAFER DICING DEVICE AND METHOD

AMENDMENT & RESPONSE UNDER 37 C.F.R. 1.116

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

*OK TO
ENTER
CDLW
10/10/06*

In response to the Final Office Action mailed July 13, 2006, please amend the application as follows: